

Mini-spectrometers

Integrating a Hamamatsu image sensor, its driver circuit, and optical elements into a compact case



Mini-spectrometers

Mini-spectrometers are compact spectrometers (polychromators) whose optical system, image sensor, and circuit are condensed into a small case.

Previous spectroscopic instruments used in the chemical analysis field and the like have been typically large and expensive. In contrast, mini-spectrometers are compact and portable, making it possible to take real-time measurements on-site, rather than having to bring in measurement samples into a room in which a spectroscopic instrument is installed.

This miniaturization also made it possible to incorporate them into various types of equipment. They are used in environmental measurement instruments, color measurement instruments, production lines, information devices and so on.

Hamamatsu provides more than 20 types of mini-spectrometers that cover the spectral range from UV to near infrared. Further, Hamamatsu offers ultra-compact types that allow them to be installed in mobile devices and collaborate with portable devices.



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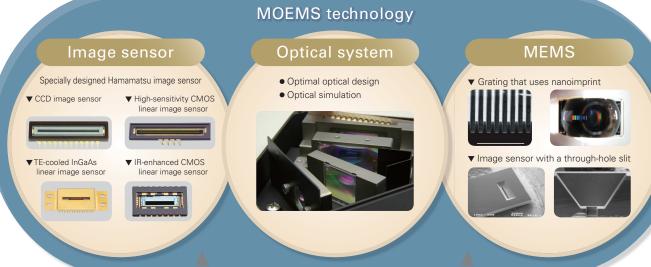
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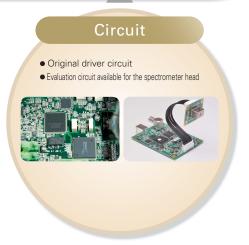
MOEMS technology that underlies mini-spectrometers

The mini-spectrometer is a product that integrates Hamamatsu's MOEMS (micro-opto-electro-mechanical-systems) technology, which combines optical technology including opto-semiconductor devices and optical systems and MEMS technology, with circuit and software. The detector serving as the core of the mini-spectrometer is a proven Hamamatsu image sensor in analysis and measurement fields. Since Hamamatsu develops its own grating, which performs spectroscopy, grating with various specifications (high resolution, wide spectral range, high diffraction in the ultraviolet region, etc.) can be mounted on its mini-spectrometers.









Applications

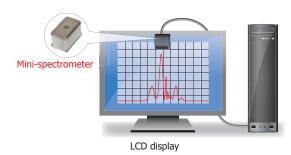
[Color measurement (e.g., LED light source)]



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A mini-spectrometer is used to perform spectral measurement and inspect LEDs or the like.

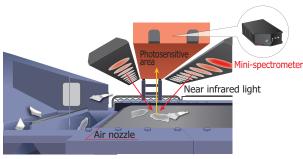
[Display color measurement]



KACCC0599E

The emission spectrum of LCDs is monitored with a micro-spectrometer.

[Plastic screening]



KACCC0601EB

Plastic screening is performed by using the fact that when near infrared light is directed at plastic, the wavelengths that are absorbed varies depending on the material.

[Environmental analysis]



KACCC0798E

Mini-spectrometers are used in environmental analysis of water, soil, and the like.

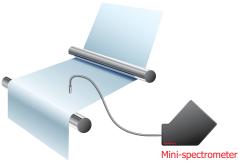
[Sugar content measurement]



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Absorbance is used in applications such as handy brix meters, which measure sugar content.

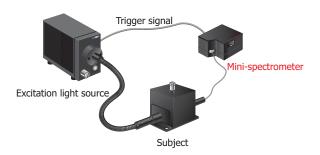
[Film thickness measurement]



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White light interferometry is used to measure the spectrum peak count, film refractive index, and film thickness from the light incident angle.

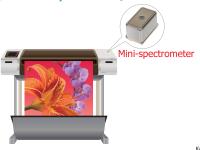
[Fluorescence measurement]



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Emission spectrum of fluorescent materials, such as fluorescent lamp and organic EL devices, is measured.

[Color adjustment]

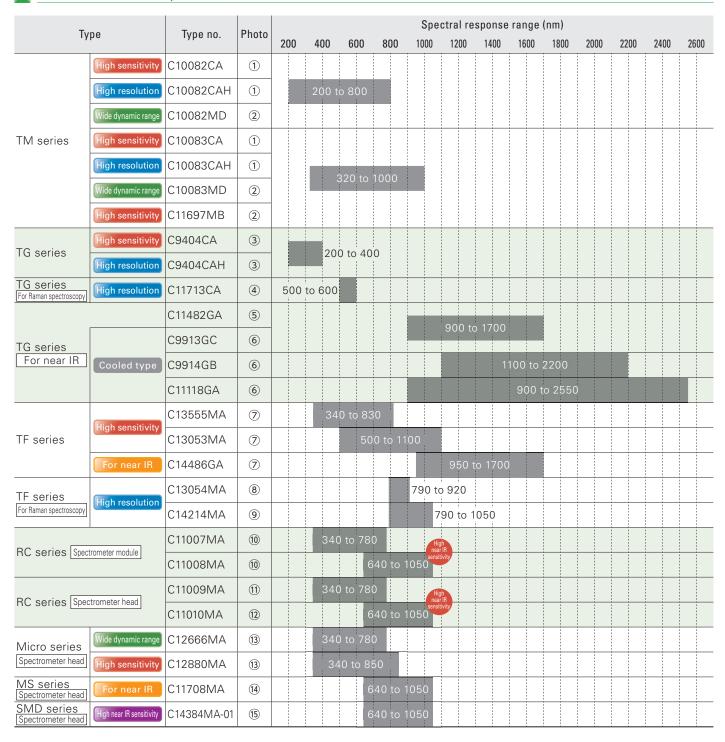


KACCC0803EB

Integrated into color printers and other printing equipment, microspectrometers monitor the color of printed materials.

Selection guide

Hamamatsu mini-spectrometers



Mini-spectrometers
Lineup











Spectral resolution	Integration time	Driving external power		Internal image sensor	nage sensor		See
max. (nm)	Integration time	supply	compat- ible	Туре	Pixels	Type no.	page
6	10 +- 10000	.5.7		Deal thinned CCD inserts	2040	C10082CA	_
1 (typ.)	10 ms to 10000 ms	+5 V	0	Back-thinned CCD image sensor	2048	C10082CAH	7
6	5 ms to 10000 ms	Not needed (USB bus power only)	0	CMOS linear image sensor	1024	C10082MD	9
8 (λ=320 to 900 nm)	40 40000	5.7		D 1 4 : 100D :	0040	C10083CA	
1 (typ.) (λ=320 to 900 nm)	10 ms to 10000 ms	+5 V		Back-thinned CCD image sensor	2048	C10083CAH	7
8	5 ms to 10000 ms	Not needed (USB bus power only)	0	CMOS linear image sensor	1024	C10083MD	9
8	30 μs to 100000 μs	Not needed (USB bus power only)	0	High-sensitivity CMOS linear image sensor	2048	C11697MB	11
3	10 1 10000	5.V		D 1 41 1 100D 1	4004	C9404CA	4.0
1 (typ.)	10 ms to 10000 ms	+5 V	0	Back-thinned CCD image sensor	1024	C9404CAH	13
0.3 (typ.)	10 ms to 10000 ms	+5 V	0	Back-thinned CCD image sensor	2048	C11713CA	15
7	6 μs to 10000 ms	Not needed (USB bus power only)	0	InGaAs linear image sensor	512	C11482GA	
7	5 ms to 10000 ms	+5 V, +12 V	-	InGaAs linear image sensor	512	C9913GC	17
8	5 ms to 1000 ms	+5 V, +12 V	-	InGaAs linear image sensor	256	C9914GB	17
20	6 μs to 40000 μs	+5 V, +12 V	0	InGaAs linear image sensor	256	C11118GA	
3	11 μs to 100000 μs	Not needed (USB bus power only)	0	High-sensitivity CMOS linear image sensor	512	C13555MA	
3.5	11 μs to 100000 μs	Not needed (USB bus power only)	0	High-sensitivity CMOS linear image sensor	512	C13053MA	
5 (typ.)	1 μs to 100000 μs	Not needed (USB bus power only)	0	InGaAs linear image sensor	256	C14486GA	19
0.4 (typ.)	11 μs to 100000 μs	Not needed (USB bus power only)	0	High-sensitivity CMOS linear image sensor	512	C13054MA	
0.6	11 μs to 100000 μs	Not needed (USB bus power only)	0	High-sensitivity CMOS linear image sensor	2048	C14214MA	
9	5 ms to 10000 ms	Not needed (USB bus power only)	-	CMOS linear image sensor	256	C11007MA	
8	5 ms to 10000 ms	Not needed (USB bus power only)	-	IR-enhanced CMOS linear image sensor	256	C11008MA	22
9	-	-	-	CMOS linear image sensor		C11009MA	22
8	-	-	-	IR-enhanced CMOS linear image sensor	256	C11010MA	
15	-	-	-	CMOS linear image sensor	256	C12666MA	
15	-	-	©* ²	High-sensitivity CMOS linear image sensor	288	C12880MA	24
20	-	-	-	CMOS linear image sensor	256	C11708MA	24
20 (λ=800 to 1050 nm)	-	-	©* ³	High-sensitivity CMOS linear image sensor	256	C14384MA-01	



TM series

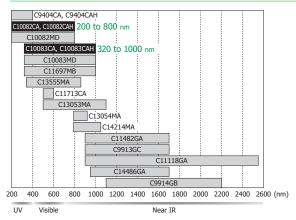
For UV to near IR

High sensitivity
High resolution

C10082CA, C10083CA C10082CAH, C10083CAH

These mimi-spectrometers are a high-sensitivity type employing a back-thinned CCD image sensor as a detector. When compared with the type with a built-in CMOS linear image sensor, the sensitivity is higher by about two orders of magnitude. It is suitable for measurement in the weak light region such as in fluorescence measurement. The C10082CAH and C10083CAH are high resolution type achieving a spectral resolution of 1 nm.

Spectral response (TM/TG/TF series)



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Features

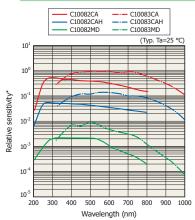
- Employs back-thinned CCD image sensor: Sensitivity improved by two orders of magnitude compared to built-in CMOS type
- High resolution: 1 nm (C10082CAH, C10083CAH)
- Spectral resolution can be varied by selecting the slit width and NA.
- High throughput using quartz transmission grating
- Installable in equipment
- Stores wavelength conversion factor*1 in internal memory
- External trigger compatible*2

Applications

- Fluorescence measurement and other low-light-level measurement
- Semiconductor process control
- Characteristic evaluation of light sources (e.g., LED)

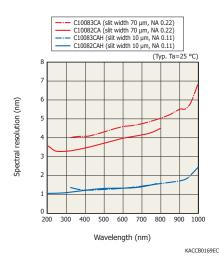
Parameter	C10082CA	C10082CAH	C10083CA	C10083CAH	Unit	
Туре	High sensitivity	High resolution	High sensitivity	High resolution	-	
Spectral response range	200 t	o 800	320 to	1000	nm	
Spectral resolution (FWHM)*3	6 max.	1 typ.	8*4 max.	1*4 typ.	nm	
Wavelength reproducibility*5	-0.2 to +0.2					
Wavelength temperature dependence		-0.04 to	0 +0.04		nm/°C	
Spectral stray light*3 *6	-33 max30 max.					
A/D conversion		1	6		bit	
Integration time		10 to	10000		ms	
Interface		USE	3 1.1		-	
USB bus power current consumption		100	max.		mA	
Driving external power supply		Į.	5		V	
Dimensions (W \times D \times H)		95 × 9	02 × 76		mm	
Weight		68	85		g	
Image sensor	Ва	ck-thinned CCD image	sensor (S10420-1106-	01)	-	
Number of pixels		20	48		pixels	
Slit*7 (H × V)	70 × 800	10 × 1000	70 × 800	10 × 1000	μm	
NA*8	0.22 0.11 0.22 0.11					
Connector for optical fiber	SMA905D					
Operating temperature*9	+5 to +40					
Storage temperature*9	-20 to +70					
Trigger compatible*2		Externa	ıl trigger		-	

Output comparison (comparison with the CMOS type)

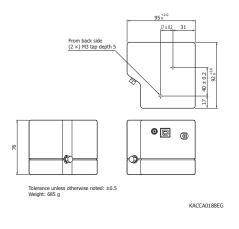


* A/D count when constant light level enters optical fiber (Fiber core diameter: 600 µm, assuming no attenuation in optical fiber)

Spectral resolution



Dimensional outline (unit: mm)



- *1: A factor for converting the pixel numbers of the image sensor to wavelengths. A calculation factor for converting the A/D converted count into a value proportional to the input light level is not provided.
- *2: External trigger coaxial cable is sold separately. For details on the trigger function, see P.32.
- *3: When the slit in the table is used. The spectral resolution depends on the slit.
- *4: λ=320 to 900 nm
- *5: Measured under constant light input and other conditions
- *6: The ratio of the count measured when the following wavelength is input to the count measured when that wavelength ±40 nm is input C10082CA, C10082CAH: 500 nm, C10083CA, C10083CAH: 650 nm
- *7: Input slit aperture size
- *8: Numeric aperture (solid angle)
- *9: No dew condensation
- Note: On the C10082CA/C10083CA series, the spectral resolution can be varied by selecting the NA and slit width. For the product lineup, see P.29.

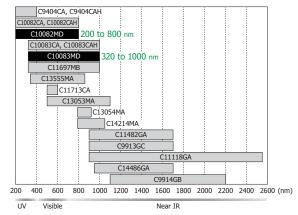
For UV to near IR

Wide dynamic range

C10082MD, C10083MD

The C10082MD and C10083MD are a high-sensitivity type employing a CMOS linear image sensor as a detector. It is suitable for spectroscopic measurement when the light level is relatively high such as in absorbance measurement or light source spectrum evaluation.

Spectral response (TM/TG/TF series)



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Features

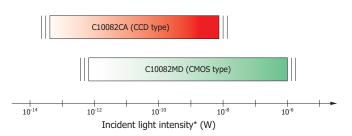
- Wide dynamic range
- High throughput using quartz transmission grating
- External power supply not necessary: Uses USB bus power
- Installable in equipment
- Stores wavelength conversion factor*1 in internal memory
- External trigger compatible*2

Applications

- Characteristic evaluation of light sources (e.g., LED)
- Transmittance and absorbance measurement of solutions and solid samples
- Sunlight and illumination light analysis

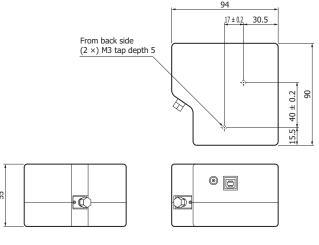
Parameter	C10082MD	C10083MD	Unit		
Туре	Wie	de dynamic range	-		
Spectral response range	200 to 800	320 to 1000	nm		
Spectral resolution (FWHM)*3	6 max.	8 max.	nm		
Wavelength reproducibility*4	-0	1.2 to +0.2	nm		
Wavelength temperature dependence	-0.0	04 to +0.04	nm/°C		
Spectral stray light*3 *5	ral stray light* ^{3 *5} -35 max33 max.				
A/D conversion		16	bit		
Integration time	5 to 10000				
Interface	USB 1.1				
USB bus power current consumption	100 max.				
Driving external power supply	N	ot needed	-		
Dimensions (W \times D \times H)	94	× 90 × 55	mm		
Weight		470	g		
Image sensor	CMOS linear imag	ge sensor (S8378-1024Q)	-		
Number of pixels		1024	pixels		
Slit*6 (H × V)	;	70 × 800	μm		
NA* ⁷		0.22	-		
Connector for optical fiber	SMA905D				
Operating temperature*8	+	-5 to +40	°C		
Storage temperature*8	-:	20 to +70	°C		
Trigger compatible*2	Exte	ernal trigger	-		

Measurable optical fiber incident light level



 * Fiber core diameter: 600 μm assuming no attenuation in optical fiber

Dimensional outline (unit: mm)



Tolerance unless otherwise noted: ± 0.5 Weight: 470 g

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*1: A factor for converting the pixel numbers of the image sensor to wavelengths. A calculation factor for converting the A/D converted count into a value proportional to the input light level is not provided.

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- *2: External trigger coaxial cable is sold separately. For details on the trigger function, see P.32.
- *3: When the slit in the table is used. The spectral resolution depends on the slit.
- *4: Measured under constant light input and other conditions
- *5: The ratio of the count measured when the following wavelength light is input to the count measured when that wavelength ±40 nm light is input C10082MD: 500 nm, C10083MD: 650 nm
- *6: Input slit aperture size
- *7: Numeric aperture (solid angle)
- *8: No dew condensation

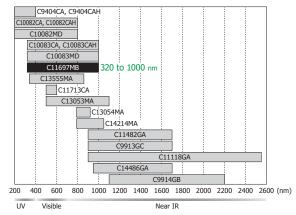
For visible to near IR

High sensitivity

C11697MB

This mini-spectrometer is based on the C10083MD optical system platform with a newly developed high-sensitivity CMOS linear image sensor. The additional trigger function that can be used for short-term integration enables spectroscopic measurement of pulse emissions. Readout time has been significantly reduced, making it suitable for LED inspection and the like in industrial lines.

Spectral response (TM/TG/TF series)



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Features

- Trigger compatible (software trigger, external trigger)*1
- High-speed readout (approx. 2 ms)
- Simultaneous charge integration type
- High sensitivity: two orders of magnitude improvement (compared to the C10083MD)
- Stores wavelength conversion factor*² in internal memory
- External power supply not necessary: Uses USB bus power
- High throughput using quartz transmission grating
- Installable in equipment

Applications

- Quality verification in LED inspection lines
- Pulse emission measurement

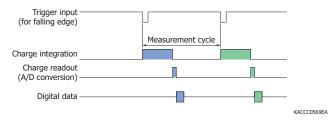
Parameter	C11697MB	Unit
Type	High sensitivity	-
Spectral response range	320 to 1000	nm
Spectral resolution (FWHM)*3	8 max.	nm
Wavelength reproducibility*4	-0.2 to +0.2	nm
Wavelength temperature dependence	-0.04 to +0.04	nm/°C
Spectral stray light*3 *5	-33 max.	dB
A/D conversion	16	bit
Integration time	30 to 100000	μs
Interface	USB 2.0	-
USB bus power current consumption	250 max.	mA
Driving external power supply	Not needed	-
Dimensions (W \times D \times H)	94 × 90 × 55	mm
Weight	470	g
Image sensor	High-sensitivity CMOS linear image sensor (S11639)	-
Number of pixels	2048	pixels
Slit*6 (H × V)	70 × 800	μm
NA* ⁷	0.22	-
Connector for optical fiber	SMA905D	-
Operating temperature*8	+5 to +40	°C
Storage temperature*8	-20 to +70	°C
Trigger compatible*1	Software trigger External trigger	-

Trigger function example

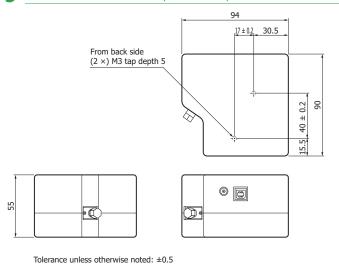
Sensor operation (integration) starts on a trigger signal, and then the digital data is acquired.

[Synchronous data measurement at external trigger input]

Sensor operation (integration) starts when an external trigger edge (rising or falling edge can be specified) is applied to the external trigger terminal, and then the digital data is acquired.



Dimensional outline (unit: mm)



KACCA0171EE

- *1: External trigger coaxial cable is sold separately. For details on the trigger function, see P.32.
- *2: A factor for converting the pixel numbers of the image sensor to wavelengths. A calculation factor for converting the A/D converted count into a value proportional to the input light level is not provided.
- *3: When the slit in the table is used. The spectral resolution depends on the slit.
- *4: Measured under constant light input and other conditions
- *5: The ratio of the count measured when an 650 nm light is input to the count measured when that wavelength ± 40nm light is input.
- *6: Input slit aperture size
- *7: Numeric aperture (solid angle)
- *8: No dew condensation

TG series



High sensitivity

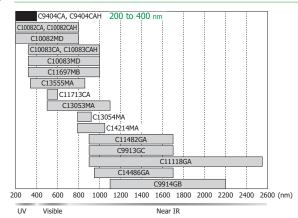
C9404CA

High resolution

C9404CAH

These mimi-spectrometers are a high-sensitivity type employing a back-thinned CCD image sensor as a detector. The C9404CA and C9404CAH are exclusively designed for UV applications (spectral response range 200 to 400 nm).

Spectral response (TM/TG/TF series)



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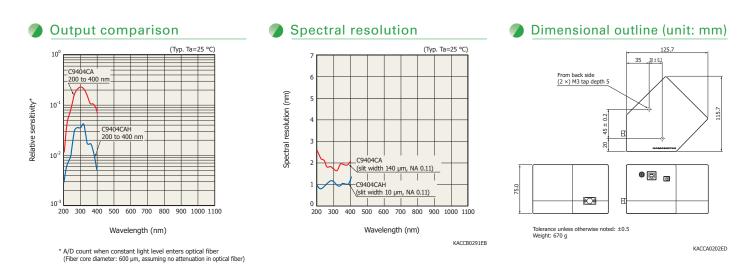
Feature:

- Employs back-thinned CCD image sensor
- High resolution: 1 nm (C9404CAH)
- High throughput using quartz transmission grating
- Stores wavelength conversion factor*1 in internal memory
- External trigger compatible*2
- Installable in equipment

Applications

- Fluorescence measurement and other low-light-level measurement
- UV light source spectrum evaluation

Parameter	C9404CA	C9404CAH	Unit		
Туре	High sensitivity	High resolution	-		
Spectral response range	200 t	o 400	nm		
Spectral resolution (FWHM)*3	3 max.	nm			
Wavelength reproducibility*4	-0.1 to	o +0.1	nm		
Wavelength temperature dependence	-0.02 to	0 +0.02	nm/°C		
Spectral stray light*3 *5	-35 ו	max.	dB		
A/D conversion	1	6	bit		
Integration time	10 to	10000	ms		
Interface	USE	-			
USB bus power current consumption	150	max.	mA		
Driving external power supply	Ę	5	V		
Dimensions (W \times D \times H)	125.7 × 1	15.7 × 75	mm		
Weight	67	70	g		
Image sensor	Back-thinned CC (S10420-	CD image sensor 1006-01)	-		
Number of pixels	10	24	pixels		
Slit*6 (H × V)	140 × 500	10 × 1000	μm		
NA* ⁷	0.	-			
Connector for optical fiber	SMA	-			
Operating temperature*8	+5 to +40				
Storage temperature*8	-20 to	o +70	°C		
Trigger compatible*2	Externa	l trigger	-		



- *1: A factor for converting the pixel numbers of the image sensor to wavelengths. A calculation factor for converting the A/D converted count into a value proportional to the input light level is not provided.
- *2: External trigger coaxial cable is sold separately. For details on the trigger function, see P.32.
- *3: When the slit in the table is used. The spectral resolution depends on the slit.

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- *4: Measured under constant light input and other conditions
- *5: The ratio of the count measured when the following wavelength light is input to the count measured when that wavelength ±20 nm light is input C9404CA/C9404CAH: 300 nm
- *6: Input slit aperture size
- *7: Numeric aperture (solid angle)
- *8: No dew condensation

For Raman spectroscopy

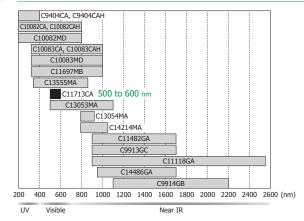
High resolution

C11713CA

This mini-spectrometer is a high resolution type suitable for Raman spectroscopy.

The spectral response range of the C11713CA is 500 to 600 nm. Spectral resolution is 0.3 nm.

Spectral response (TM/TG/TF series)



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Features

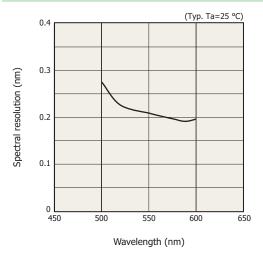
- High resolution: 0.3 nm typ.
- Compact size: Installable in equipment
- High throughput using quartz transmission grating
- Employs back-thinned CCD image sensor with improved etaloning characteristics
- Stores wavelength conversion factor*1 in internal memory
- External trigger compatible*2

Applications

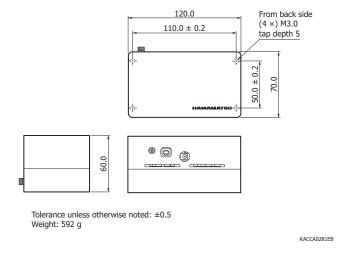
■ Raman spectroscopy

Parameter	C11713CA	Unit			
Туре	For Raman spectroscopy High resolution	-			
Spectral response range	500 to 600	nm			
Spectral resolution (FWHM)*3	resolution (FWHM)*3 0.3 typ., 0.5 max.				
Wavelength reproducibility*4	-0.1 to +0.1	nm			
Wavelength temperature dependence	-0.04 to +0.04	nm/°C			
Spectral stray light*3 *5	-30 max.	dB			
A/D conversion	16	bit			
Integration time	10 to 10000	ms			
Interface	USB 1.1	-			
USB bus power current consumption	150 max.	mA			
Driving external power supply	5	V			
Dimensions (W \times D \times H)	120 × 70 × 60	mm			
Weight	592	g			
Image sensor	Back-thinned CCD image sensor (S10420-1106-01)	-			
Number of pixels	2048	pixels			
Slit* ⁶ (H × V)	10 × 1000	μm			
NA* ⁷	0.11	-			
Connector for optical fiber	SMA905D	-			
Operating temperature*8	+5 to +40	°C			
Storage temperature*8	-20 to +70	°C			
Trigger compatible*2	External trigger	-			

Spectral resolution vs. wavelength



Dimensional outline (unit: mm)



*1: A factor for converting the pixel numbers of the image sensor to wavelengths. A calculation factor for converting the A/D converted count into a value proportional to the input light level is not provided.

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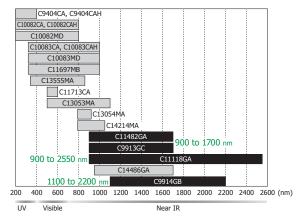
- *2: External trigger coaxial cable is sold separately. For details on the trigger function, see P.32.
- *3: When the slit in the table is used. The spectral resolution depends on the slit.
- *4: Measured under constant light input and other conditions
- *5: The ratio of the count measured when the following wavelength light is input to the count measured when that wavelength ±10 nm light is input C11713CA: 550 nm
- *6: Input slit aperture size
- *7: Numeric aperture (solid angle)
- *8: No dew condensation

For near IR

C11482GA, C9913GC C9914GB, C11118GA

Near infrared light detection mini-spectrometers employing InGaAs linear image sensor. The three available spectral response ranges are 0.9 to 1.7 $\mu m,~1.1$ to 2.2 $\mu m,~0.9$ to 2.55 $\mu m.$ Low-noise, TE-cooled types are also available.

Spectral response (TM/TG/TF series)



KACCB0165EG



Features

- Low noise (cooled type: C9913GC, C9914GB, C11118GA)
- External power supply not necessary, USB bus powered*1 (C11482GA)
- High throughput using quartz transmission grating
- Installable in equipment
- Stores wavelength conversion factor*2 in internal memory
- Trigger compatible (software trigger, external trigger): C11482GA, C11118GA

Applications

[C11482GA]

- Moisture measurement
- Evaluation of optical communication components
- Film thickness measurement

[C9913GC, C9914GB]

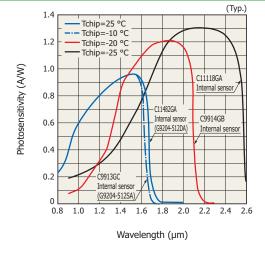
- Moisture measurement
- Composition analysis in the foods and agricultural sectors
- Chemical product process control
- \blacksquare Plastic sorting

[C11118GA]

- CH group absorption (2.3 µm band) measurement
- Soil analysis, component analysis
- Plastic sorting

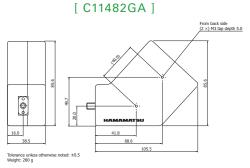
Parameter	C11482GA	C9913GC	C9914GB	C11118GA	Unit	
Photo					-	
Туре	For near IR		For near IR Cooled type		-	
Spectral response range	900 to 1700	900 to 1700	1100 to 2200	900 to 2550	nm	
Spectral resolution (FWHM)*3	7 max.	7 max.	8 max.	20 max.	nm	
Wavelength reproducibility*4	-0.2 to +0.2	-0.2 to +0.2	-0.4 to +0.4	-0.8 to +0.8	nm	
Wavelength temperature dependence	-0.04 to +0.04	-0.02 to +0.02	-0.04 to +0.04	-0.08 to +0.08	nm/°C	
Spectral stray light*3	-33 max.* ⁵	-35 n	nax.* ⁵	-30 max.* ⁶	dB	
A/D conversion		1	6		bit	
Integration time*7 *8	6 μs to 10000 ms	5 ms to 10000 ms	5 ms to 1000 ms	6 μs to 40000 μs	-	
Interface	USB 2.0	USE	USB 2.0	-		
USB bus power current consumption	350 max.		250 max.		mΑ	
Driving external Power supply for cooling element*9	Not needed	5/1.8 max.	5/2.8 max.	5/2.8 max.	V/A	
power supply for cooling fan*9		12/0.2 max.			V/A	
Dimensions (W \times D \times H)	38.5 × 106 × 86	142 × 218 × 82				
Weight	280		1700		g	
Image sensor	InGaAs linear image sensor (G9204-512DA)	TE-cooled type InGaAs linear image sensor (G9204-512SA)	TE-cooled type InGaAs linear image sensor	TE-cooled type InGaAs linear image sensor	-	
Number of pixels	512* ¹⁰	512* ¹⁰	256* ¹⁰	256* ¹¹	pixels	
Slit*12 (H × V)	70 × 500	70 ×	500	140 × 500	μm	
NA*13		0.	22		-	
Connector for optical fiber		SMA	905D		-	
Operating temperature*14	+5 to +40	+	+5 to +35 (+5 to +30*15	5)	°C	
Storage temperature*14	-20 to +70		-20 to +70		°C	
Trigger compatible*16	Software trigger External trigger	-	-	Software trigger External trigger	-	

Spectral response of InGaAs linear image sensors



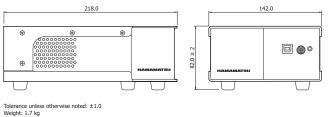
*1: C9913GC, C9914GB, C11118GA: 5 V and 12 V power supplies required *2: A conversion factor for converting image sensor pixel numbers into wavelengths. A calculation factor for converting the A/D converted count into a value proportional to the input light level is not provided. *3: When the slit in the table is used. The spectral resolution depends on the slit. *4: Measured under constant light input and other conditions *5: The ratio of the count measured when the following wavelength light is input

Dimensional outlines (unit: mm)



KACCA0146EE

[C9913GC, C9914GB, G11118GA]



KACCA0368E

to the count measured when that wavelength ±40 nm light is input, C11482GA/C9913GC: 1300 nm, C9914GB: 1650 nm *6: The ratio of the count measured when a 1700 nm light is input to the count measured when that wavelength ±80 nm light is input *7: Depends on the image sensor dark current *8: Excludes defect pixels *9: Maximum value under steady-state condition. Note that inrush current flows at startup. Connector for external power supply included (C9913GC, C9914GB, C11118GA) *10: No defect pixels (when set to low gain). Defect pixels are pixels that are outside the specifications of the image sensor's electrical and optical characteristics. *11: Up to three non-consecutive defect pixels may be present (when set to low gain). Defect pixels are pixels that are outside the specifications of the image sensor's electrical and optical characteristics. *12: Input slit aperture size *13: Numeric aperture (solid angle) *14: No dew condensation *15: Operating temperature in which cooling control is possible *16: External trigger coaxial cable is sold separately. For details on the trigger function, see R32.

TF series

Thin type

High sensitivity

C13555MA, C13053MA

For near IR

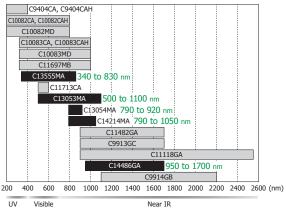
C14486GA

High resolution

C13054MA, C14214MA

These mini-spectrometers are a thin type that has achieved 12 mm thickness while maintaining high performance. The incorporation of a high-sensitivity CMOS image sensor has achieved high sensitivity equivalent to that of a CCD and low power consumption. Moreover, the trigger function that can be used for short-term integration enables spectroscopic measurement of pulse emissions. The C13054MA is a high resolution mini-spectrometer suitable for Raman spectroscopy.





KACCB0387EC



Feature

- Compact, thin case
- High-sensitivity CMOS image sensor built in (high sensitivity equivalent to that of a CCD)
- Trigger compatible (software trigger, external trigger)*1
- High throughput using quartz transmission grating
- External power supply not necessary (USB bus powered)
- Installable in equipment
- Stores wavelength conversion factor*2 in internal memory

Applications

[C13555MA]

- Visible light source inspection
- Color measurement

[C13053MA]

- Sugar content and acidity detection of foods
- Film thickness gauge

[C13054MA, C14214MA]

■ Raman spectroscopy

[C14486GA]

■ Sugar content of foods, moisture measurement

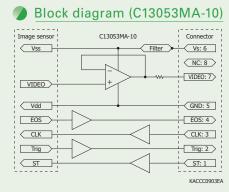
Specifications of C13555MA, C13053MA and C14486GA (Ta=25 °C)

Parameter	C13555MA	C13053MA	C14486GA	Unit	
Photo	· ce	(12	i ca	-	
Туре	High ser	nsitivity	For near IR	-	
Spectral response range	340 to 830	500 to 1100	950 to 1700	nm	
Spectral resolution (FWHM)*3	2.3 typ., 3.0 max.	2.5 typ., 3.5 max.	5.0 typ., 7.0 max.	nm	
Wavelength reproducibility*4	-0.2 to +0.2	-0.4 to +0.4	-0.4 to +0.4	nm	
Wavelength temperature dependence	-0.04 to +0.04 -0.05 to +0.05				
Spectral stray light*3	-33 max.* ⁵ -33 max.* ⁵				
A/D conversion	16				
Integration time	11 to 100000 1 to 100000				
Interface		USB 2.0		-	
USB bus power current consumption		250 max.		mA	
Driving external power supply		Not needed		V	
Dimensions (W \times D \times H)		80 × 60 × 12		mm	
Weight		88		g	
Image sensor	High-sensitivity CMO	S linear image sensor	InGaAs linear image sensor	-	
Number of pixels	51	2	256	pixels	
Slit (H × V)*6		25 × 250		μm	
NA* ⁷		0.22		-	
Connector for optical fiber	SMA905D				
Operating temperature*8	+5 to +50				
Storage temperature*8	-20 to +70				
Trigger compatible*1	Software trigger External trigger				

With I/O connector C13555MA-10, C13053MA-10

The C13555MA-10 and C13053MA-10 are spectrometer heads with an I/O connector for integration into devices. They have the same optical system and image sensor as the C13555MA or C13053MA. Video signals can be captured by applying drive signals.





- *1: External trigger coaxial cable is sold separately. For details on the trigger function, see P.32.
- *2: A conversion factor for converting image sensor pixel numbers into wavelengths. A calculation factor for converting the A/D converted count into a value proportional to the input light level is not provided.
- *3: When the slit in the table is used. The spectral resolution depends on the slit.
- *4: Measured under constant light input and other conditions
- *5: The ratio of the count measured when light at following wavelengths is input to the count measured when that wavelength ±40 nm light is input C13555MA: 600 nm, C13053MA: 800 nm, C14486GA: 1300 nm
- *6: Input slit aperture size
- *7: Numeric aperture (solid angle)
- *8: No dew condensation

Specifications of C13054MA and C14214MA (Ta=25 °C)

Parameter	C13054MA	C14214MA	Unit			
Photo			-			
Type	For Raman spectroscop	High resolution	-			
Spectral response range	790 to 920	790 to 1050	nm			
Spectral resolution (FWHM)*1	0.4 typ., 0.7 max.	0.4 typ., 0.6 max.	nm			
Wavelength reproducibility*2	-0.2 to	0 +0.2	nm			
Wavelength temperature dependence	-0.02 to	0 +0.02	nm/°C			
Spectral stray light*1	-33 n	-33 max.* ³				
A/D conversion	1	bit				
Integration time	11 to 1	00000	μs			
Interface	USE	3 2.0	-			
USB bus power current consumption	250	max.	mA			
Driving external power supply	Not no	eeded	V			
Dimensions (W \times D \times H)	80 × 60 × 12	100 × 60 × 12	mm			
Weight	88	95	g			
Image sensor	High-sensitivity CMO	S linear image sensor	-			
Number of pixels	512	2048	pixels			
Slit (H × V)*4	10 ×	400	μm			
NA* ⁵	0.	11	-			
Connector for optical fiber	SMA905D					
Operating temperature*6	+5 to +50					
Storage temperature*6	-20 to	o +70	°C			
Trigger compatible*7	Softwar Externa	e trigger I trigger	-			

^{*1:} When the slit in the table is used. The spectral resolution depends on the slit. *2: Measured under constant light input and other conditions *3: The ratio of the count measured when an 860 nm light is input to the count measured when that wavelength ±10 nm light is input *4: Input slit aperture size *5: Numeric aperture (solid angle) *6: No dew condensation *7: External trigger coaxial cable is sold separately. For details on the trigger function, see P.32.

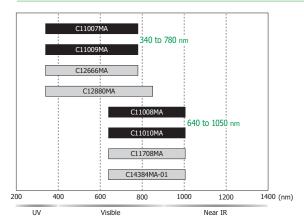
RC series

Compact, low price type

C11007MA, C11008MA C11009MA, C11010MA

These are spectrometers with reflective grating and CMOS linear image sensor integrated into a compact form. USB output spectrometer modules (C11007MA, C11008MA) equipped with a driver circuit and spectrometer heads (C11009MA, C11010MA) for installation in equipment are available.

Spectral response (RC/Micro/MS/SMD series)



KACCB0389EB



Features

[C11007MA, C11008MA (spectrometer modules)]

- Integrated spectrometer head and driver circuit
- Spectroscopic measurement possible on a PC
- External power supply not necessary: Uses USB bus power
- A/D conversion: 16-bit
- Stores wavelength conversion factor*8 in internal memory

[C11009MA, C11010MA (spectrometer heads)]

- For installation in devices
- Optical system and image sensor housed in a compact case
- Low cost
- Wavelength conversion factor*8 is listed on final inspection sheet.

Applications

[C11007MA, C11009MA]

- Installation into measuring devices
- Chemical measurement
- Visible light source inspection
- Color measurement

[C11008MA, C11010MA]

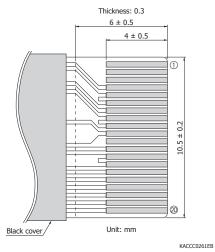
- Installation into measuring devices
- Chemical measurement
- Sugar content measurement of fruits
- Various industrial measurements

^{*8:} A factor for converting image sensor pixel numbers into wavelengths. A calculation factor for converting the A/D converted count into a value proportional to the input light level is not provided.

Parameter	C11007MA	C11009MA	C11008MA	C11010MA	Unit		
Photo					-		
Type	Spectrometer module	Spectrometer head	Spectrometer module	Spectrometer head	-		
Spectral response range	340 t	o 780	640 to 10	High near IR sensitivity	nm		
Spectral resolution (FWHM)*1	9 m	nax.	8 m	iax.	nm		
Wavelength reproducibility*2		-0.5 to) +0.5		nm		
Wavelength temperature dependence		-0.05 to	0 +0.05		nm/°C		
Spectral stray light*1 *3	-30 max.						
A/D conversion	16	-	16	-	bit		
Integration time	5 to 10000	-	5 to 10000	-	ms		
Interface	USB 1.1	-	USB 1.1	-	-		
USB bus power current consumption	150 max.	-	150 max.	-	mA		
External driving power supply	Not needed	-	Not needed -		-		
Dimensions (W \times D \times H)	55 × 100 × 48	28 × 28 × 28	55 × 100 × 48	$35 \times 28 \times 20$	mm		
Weight	180	52	168	45	g		
Built-in spectrometer head	C11009MA	-	C11010MA	-	-		
Image sensor	CMOS linear image s	sensor (S8378-256N)	IR-enhanced CMOS	linear image sensor	-		
Number of pixels		25	56		pixels		
Slit*4 (H × V)	70 ×	550	70 ×	2500	μm		
NA*5		0	22		-		
Fiber core diameter	600						
Connector for optical fiber	SMA905D						
Operating temperature*6	+5 to +40						
Storage temperature*6		-20 to	+70		°C		
Trigger compatible			-		-		

Electrical connection with external circuit (C11009MA, C11010MA)

The flexible board extending from the spectrometer head is used to electrically connect with external circuits.



No.	Symbol	1/0	Description	No.	Symbol	1/0	Description
1	NC		No connection	11)	NC		No connection
2	NC		No connection	12	Gain	1	Image sensor: gain setting
3	NC		No connection	13	A.GND	-	Analog GND
4	EOS	0	Sensor scan end signal	14)	A.GND	-	Analog GND
5	A.GND	-	Analog GND	15	ST	1	Sensor scan start signal
6	A.GND	-	Analog GND	16	CLK	1	Sensor scan sync signal
7	Video	0	Video output signal	17)	SDA	0	Temperature sensor output signal
8	A.GND	-	Analog GND	18	SCL	1	Temperature sensor drive signal
9	A.GND	-	Analog GND	19	D.GND	-	Temperature sensor digital GND
10	+5 V		Image sensor power supply: +5 V	20	VCC	1	Temperature sensor: +3.3 V

- · 4 to 10 and 12 to 16 are connected to the image sensor.
- For the drive conditions, refer to the S8377/S8378 series CMOS linear image sensor datasheet.

 ① to ② are connected to the temperature sensor (DS1775R by DALLAS) built into the spectrometer.

^{*1:} When the slit in the table is used. The spectral resolution depends on the slit. *2: Measured under constant light input and other conditions *3: The ratio of the count measured when a 550 nm (C11007MA, C11009MA) or 850 nm (C11008MA, C11010MA) light is input to the count measured when that wavelength ±40 nm light is input *4: Input slit aperture size *5: Numeric aperture (solid angle) *6: No dew condensation

Micro series, MS series, SMD series

Ultra-compact spectrometer heads

Wide dynamic range

C12666MA

High sensitivity

C12880MA

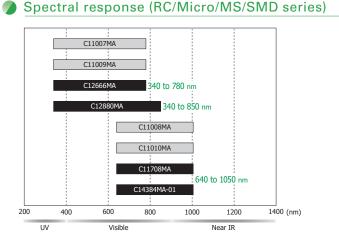
For near IR

C11708MA

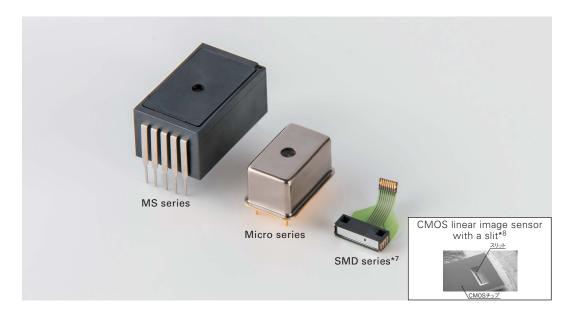
High near IR sensitivity

C14384MA-01

Based on an advanced MOEMS technology, a thumb-sized ultra-compact spectrometer heads have been achieved by combining an input-slit-integrated CMOS image sensor and grating formed through nanoimprint on a convex lens. As they employ an easily mountable package, you can use them as though they were sensors.



KACCB0388E



Features

- Ultra-compact
- Hermetically sealed package: High reliability under humid conditions (C12666MA, C12880MA)
- For installation into mobile measuring devices
- Wavelength conversion factor*9 is listed on final inspection sheet.
- High-sensitivity CMOS image sensor built in (C12880MA, C14384MA-01)

Applications

[C12666MA, C12880MA]

- Color monitoring on printers, printing presses, etc.
- Tester for lights, LEDs, etc.
- Display color adjustment
- Water quality control monitors and other environment measuring instruments
- Measuring instruments that use portable devices, such as smartphones and tablets

[C11708MA, C14384MA-01]

- Sugar content measurement of fruits
- Taste evaluation of grains
- Composition analysis

^{*7:} Do not use the concavities. Their shapes and positions may be changed.

^{*8:} Micro series, SMD series

^{*9:} A factor for converting image sensor pixel numbers to wavelengths. A calculation factor for converting the A/D converted count into a value proportional to the input light level is not provided.

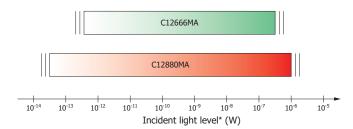
D	Micro series			
Parameter	C12666MA	C12880MA	- Unit	
Photo				
Type	Spectrometer head Wide dynamic range	Spectrometer head High sensitivity	-	
Spectral response range	340 to 780	340 to 850	nm	
Spectral resolution (FWHM)*1	15	max.	nm	
Wavelength reproducibility*2	-0.5 to +0.5			
Wavelength temperature dependence	-0.1 t	0 +0.1	nm/°C	
Spectral stray light*1 *3	-25	max.	dB	
Dimensions (W \times D \times H)	20.1 × 1	2.5 × 10.1	mm	
Weight		5	g	
Image sensor	CMOS linear image sensor	High-sensitivity CMOS linear image sensor	-	
Number of pixels	256	288	pixels	
Slit (H × V)*4	50 × 750	50 × 500	μm	
NA* ⁵	0.22			
Operating temperature*6	+5 to +50			
Storage temperature*6	-20 to +70			
Trigger compatible	-			
Evaluation circuit (sold separately)	tely) C14465-10 C13016		-	

Note: We also provide the C12880MA-10, which is identical to the C12880MA except that it has an SMA connector.

Measurable incident light level

CMOS image sensor built into the C12666MA has a large saturation charge, and that built into the C12880MA has a large charge-to-voltage conversion gain.

To perform high S/N measurement, the C12666MA is recommended when the incident light level is high and the C12880MA when the level is low.



^{*} Input spot diameter: 800 μ m (C12666MA: λ =560 nm, C12880MA: λ =600 nm) The measurable light level is calculated from the settable integration time. The settable integration time is different between the C12666MA and C12880MA. The S/N during measurement is not taken into account.

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Related products

Evaluation circuit for micro series

A circuit board designed to simply evaluate the characteristics of the micro series is available (sold separately). The micro series is connected to a PC with a USB cable A9160 (AB type, sold separately). Evaluation software is included.



Mini-spectrometer C13985 series

The C13985 series are USB connection type modules with minispectrometer (C12880MA or C12880MA-10) mounted. Spectroscopic measurement using evaluation software is possible when connected to a PC using a Micro USB cable (AB type).





C13985 C13985-10

^{*1:} When the slit in the table is used. The spectral resolution depends on the slit. *2: Measured under constant light input and other conditions *3: The ratio of the count measured when the following wavelength light is input to the count measured when that wavelength ±40 nm light is input, C12666MA: 560 nm, C12880MA: 655 nm *4: Input slit aperture size *5: Numeric aperture (solid angle) *6: No dew condensation

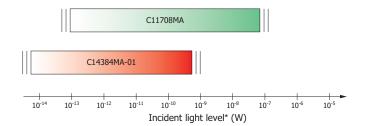


Parameter	MS series	SMD series	Unit	
raidilletei	C11708MA	C14384MA-01	Oill	
Photo			-	
Туре	Spectrometer head For near IR	Spectrometer head High near IR sensitivity	-	
Spectral response range	640 to 1050	640 to 1050	nm	
Spectral resolution (FWHM)*7	20 max.	25 max. (640 to 800 nm) 20 max. (800 to 1050 nm)		
Wavelength reproducibility*8	-0.5 to +0.5	-0.5 to +0.5		
Wavelength temperature dependence	-0.05 to +0.05	-0.1 to +0.1		
Spectral stray light*7 *9	-25 max.	-23 max.		
Dimensions (W \times D \times H)	27.6 × 16.8 × 13	11.5 × 4.0 × 3.1	mm	
Weight	9	0.3	g	
Image sensor	CMOS linear image sensor	High sensitivity CMOS linear image sensor	-	
Number of pixels	256	256	pixels	
Slit (H × V)*10	75 × 750	15 × 300	μm	
NA*11	0.22	0.22	-	
Operating temperature*12	+5 to +50	+5 to +50	°C	
Storage temperature*12	-20 to +70	-20 to +70	°C	
Trigger compatible	-	-	-	
Evaluation circuit (sold separately)	C14465	C14989	-	

Measurable incident light level

CMOS image sensor built into the C11708MA has a large saturation charge, and that built into the C14384MA-01 has a large charge-tovoltage conversion gain.

To perform high S/N measurement, the C11708MA is recommended when the incident light level is high and the C14384MA-01 when the level is low.



* Input spot diameter: 800 μ m (λ =850 nm) The measurable light level is calculated from the settable integration time. The settable integration time is different between the C11708MA and C14384MA-01. The S/N during measurement is not taken into account.

KACCB0629FA

Related products



Evaluation circuit for MS/SMD series

A circuit board designed to simply evaluate the characteristics of the MS/SMD series is available (sold separately). The MS/SMD series is connected to a PC with a USB cable A9160 (AB type, sold separately). Evaluation software is included.





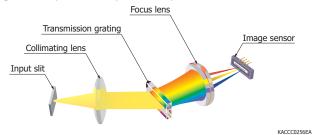
*7: When the slit in the table is used. The spectral resolution depends on the slit. *8: Measured under constant light input and other conditions *9: The ratio of the count measured when the following wavelength light is input to the count measured when that wavelength ±40 nm light is input, C11708MA and C14384MA-01: 850 nm *10: Input slit aperture size *11: Numeric aperture (solid angle) *12: No dew condensation *13: The C15036 is equipped with the mini-spectrometer C14384MA-01.

Technical note

1 Structure

Wavelength dispersive spectrometers are broadly grouped into monochromator and polychromator types. Monochromators use a grating as the wavelength dispersing element for separating the incident light into a monochromatic spectrum. Polychromators utilize the principle of monochromators and are designed to allow simultaneous detection of multiple spectra. Minispectrometers fall under the polychromator type. In monochromators, an exit slit is usually formed on the focal plane of a focus lens, while in polychromators an array type detector (image sensor) is placed along the focal plane of the focus mirror/lens. To make mini-spectrometers compact, the polychromators use a collimating lens and focus mirror/lens with a shorter focal distance compared to monochromators.

[Figure 1] Optical component layout (TG series)



The function of each component is explained below.

Input slit

The input slit is the opening for receiving the light to be measured. The input slit restricts the spatial spread of the measurement light that enters the mini-spectrometer, and the slit image of the incident light is focused on the image sensor. The narrower the input slit, the more the spectral resolution is improved, but the throughput becomes lower. An optical fiber is connected to the mini-spectrometer input slit.

Collimating mirror/lens

The light passing through the input slit spreads at a certain angle. The collimating mirror/lens collimate this slit transmitted light and guide it onto the grating. At this point, an aperture (aperture mask) is used along with the collimating mirror/lens to limit the NA (numerical aperture) of the light flux entering the mini-spectrometer.

Grating

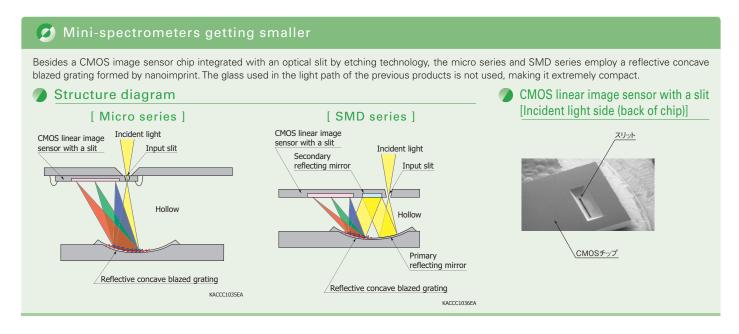
The grating separates the incident light guided through the collimating mirror/lens into each wavelength and lets the light at each wavelength pass through or be reflected at a different diffraction angle. There are two types of gratings for mini-spectrometers: transmission type and reflection type.

>> Focus mirror/lens

The focus mirror/lens focuses the light from the grating onto an image sensor in the order of wavelength.

Image sensor

The image sensor converts the spectrum of light focused according to each wavelength by the focus mirror/lens into electrical signals, and then outputs them. Cooled minispectrometers incorporate a thermoelectrically cooled image sensor to reduce image sensor noise.

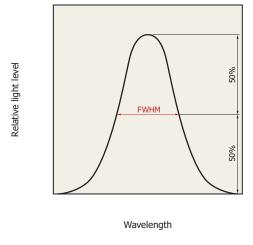


>> Spectral resolution

(1) Definition of spectral resolution

The spectral resolution of mini-spectrometers is defined based on the full width at half maximum (FWHM). FWHM is the spectral width at 50% of the peak power value as shown in Figure 2. Figure 3 shows examples of spectral resolution measured with different types of mini-spectrometers.

[Figure 2] Definition of full width at half maximum



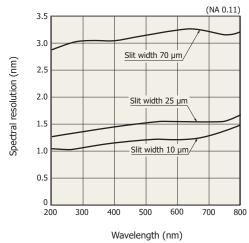
(2) Changing the spectral resolution

The spectral resolution of mini-spectrometers varies depending on the slit width and NA. In the C10082CA, for example, the slit width is 70 µm and the NA is 0.22. Figure 4 shows typical examples of spectral resolution when the NA is changed to 0.11 and the slit width is narrowed. This proves that the spectral resolution can be improved down to about 1 nm by changing conditions.

However, narrowing the slit width and reducing the NA will limit the light incident on the mini-spectrometer. The light level reaching the image sensor will therefore decrease.

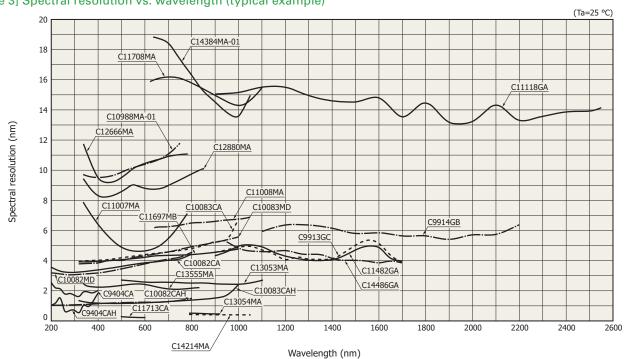
For example, when comparing the C10082CA with the C10082CAH, the slit width of the C10082CA is 70 μm while that of the C10082CAH is 10 μm , which is 1/7 of the C10082CA. This means that the light level passing through the slit of the C10082CAH is 1/7 of the C10082CA. On the other hand, due to the difference in the NA in the spectrometers, the light level that reaches the C10082CAH image sensor is approximately 1/4th the level that reaches the C10082CA image sensor. However, because the spectral resolution of the C10082CAH approximately 1/4th that of the C10082CA, the A/D count of the C10082CAH is approximately 4 times that of the C10082CA. As a result, when the light level entering the optical fiber is the same, the A/D count of the C10082CAH is approximately 1/7th that of the C10082CA.

[Figure 4] Spectral resolution vs. wavelength (typical example when slit width and NA for C10082CA were changed)



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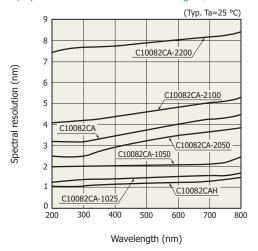
[Figure 3] Spectral resolution vs. wavelength (typical example)

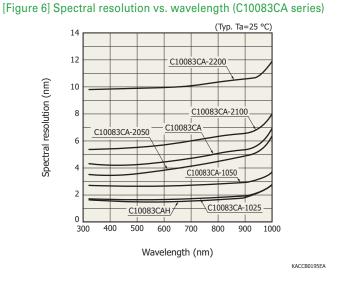


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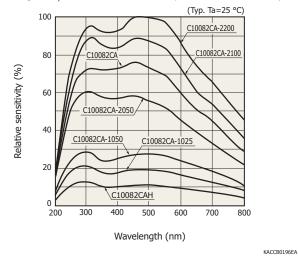
Figures 5 and 6 show the spectral resolution of the C10082CA/C10083CA series, and Table 1 shows the NA and slit width.

[Figure 5] Spectral resolution vs. wavelength (C10082CA series)

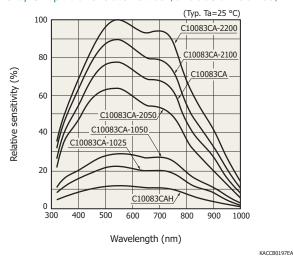




[Figure 7] Output characteristics (C10082CA series)



[Figure 8] Output characteristics (C10083CA series)



[Table 1] C10082CA/C10083CA series NA and slit width

Type no.				
Spectral response range 200 to 800 nm	Spectral response range 320 to 1000 nm	NA NA	Slit width	
C10082CA-2200	C10083CA-2200		200 μm	
C10082CA-2100	C10083CA-2100	0.22	100 μm	
C10082CA	C10083CA	0.22	70 μm	
C10082CA-2050	C10083CA-2050		50 μm	
C10082CA-1050	C10083CA-1050		50 μm	
C10082CA-1025	C10083CA-1025	0.11	25 μm	
C10082CAH	C10083CAH		10 μm	

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(3) Spectral detection width assigned per pixel of image sensor This section describes the spectral detection width that is assigned per pixel of the image sensor mounted in a minispectrometer. The spectral detection width is different from spectral resolution. The approximate spectral detection width assigned per pixel is obtained by dividing the spectral response range by the number of pixels of the image sensor.

• Example: C10082CA (spectral response range: 200 to 800 nm, 2048 pixels)

Spectral detection width assigned per pixel = (800 - 200)/2048 ≈ 0.3 nm··· (1)

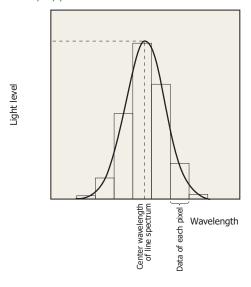
The detection wavelength of any given pixel is calculated from equation (2) using the wavelength conversion factor that is written in the EEPROM in the mini-spectrometer. This allows obtaining the wavelength assigned to any pixel.

Detection wavelength of any given pixel [nm] = $a_0 + a_1pix + a_2pix^2 + a_3pix^3 + a_4pix^4 + a_5pix^5$... (2)

ao to as: wavelength conversion factor pix: any pixel number of image sensor (1 to the last pixel)

Hamamatsu mini-spectrometers are designed so that the spectral width assigned per pixel in the image sensor is small relative to the spectral resolution. When a line spectrum is measured with a mini-spectrometer, the output is divided into multiple pixels as shown in Figure 9. The center wavelength of the line spectrum can be found by approximating this measurement result with a Gaussian curve.

[Figure 9] Finding the center wavelength of line spectrum by approximation



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Stray light

Stray light is generated as a result of extraneous light entering the detector (image sensor), which should not be measured. The following factors can generate stray light.

- · Fluctuating background light
- \cdot Imperfections in the grating
- · Reflection from lens, detector window, and detector photosensitive area

Definition of stray light

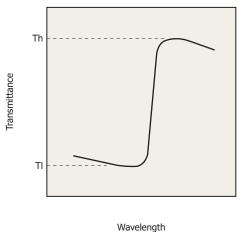
There are two methods to define stray light: one method uses a long-pass filter and the other method uses reference light in a narrow spectral range (light output from a monochromator or line spectra emitted from a spectral line lamp, etc.).

The long-pass filter method uses light obtained by making white light pass through a long-pass filter for particular wavelengths. In this case, the stray light is defined as the ratio of transmittance in the "wavelength transmitting" region to transmittance in the "wavelength blocking" region. The stray light level (SL) in this case is defined by equation (3). (See Figure 10 for the definitions of Tl and Th.)

$$SL = 10 \times log(TI/Th) \cdots (3)$$

This definition allows measuring the effects of stray light over a wide spectral range and so is used as an evaluation method suitable for actual applications such as fluorescence measurement. However, be aware that the intensity profile of white light used as reference light will affect Tl and Th values.

[Figure 10] Definitions of TI and Th



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In the other method using reference light in a narrow spectral range, the stray light level is defined by equation (4).

$$SL = 10 \times log(I_M/I_R) \cdots (4)$$

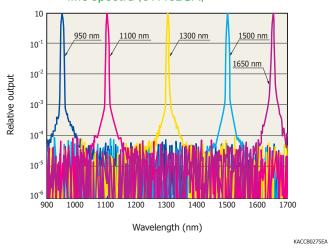
Im: unnecessary light level that was output at wavelengths deviating from the reference light spectrum

In: reference light level

This definition is not affected by the reference light because the measurement conditions are simple.

In both definition methods, the stray light conditions will differ depending on the wavelength to be detected. The stray light should therefore be measured at multiple wavelengths.

[Figure 11] Examples of stray light measurement using line spectra (C11482GA)



Sensitivity

The output charge of an image sensor mounted in minispectrometers is expressed by equation (5).

$$Q(\lambda) = k(\lambda) \times P(\lambda) \times Texp \cdots (5)$$

Q(λ): image sensor output charge [C]

 $k(\lambda)$: conversion factor for converting the light level entering a mini-spectrometer into image sensor output charge (equals the product of optical system efficiency, diffraction efficiency of grading, and image sensor sensitivity)

 $P(\lambda)$: incident light level [W] at each wavelength incident on mini-spectrometer Texp: integration time [s]

The output charge of an image sensor is converted into a voltage by the charge-to-voltage converter circuit and then converted into a digital value by the A/D converter. This is finally derived from the mini-spectrometer as an output value. The output value of a mini-spectrometer is expressed by equation (6).

$$I(\lambda) = \varepsilon \times Q(\lambda) = \varepsilon \times k(\lambda) \times P(\lambda) \times Texp \cdots (6)$$

I(λ): mini-spectrometer output value [counts]

 ϵ : conversion factor for converting image sensor output charge into a mini-spectrometer output value (equals the product of the charge-to-voltage converter circuit constant and the A/D converter resolution)

Meanwhile, the sensitivity of a mini-spectrometer is expressed by equation (7).

$$E(\lambda) = I(\lambda)/\{P(\lambda) \text{ Texp}\} \dots (7)$$

E(λ): sensitivity of mini-spectrometer [counts/(W·s)]

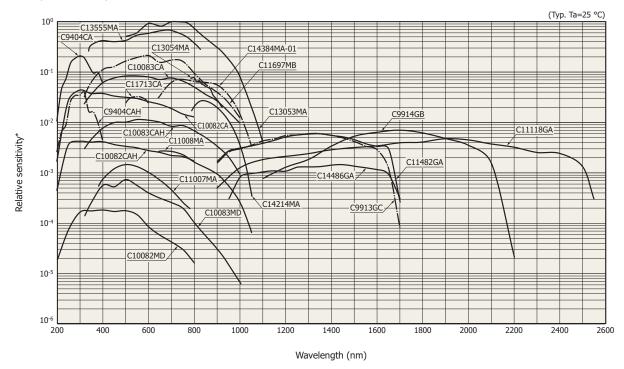
When equation (6) is substituted into equation (7), we obtain equation (8).

$$E(\lambda) = \varepsilon \times k(\lambda) \cdots (8)$$

[Table 2] Wavelength dependence of parameters that determine conversion factor

Parameter determining conversion factor	Wavelength dependence
Optical system efficiency	Yes
Diffraction efficiency of grating	Yes
Image sensor sensitivity	Yes
Charge-to-voltage converter circuit constant	No
A/D converter resolution	No

[Figure 12] Spectral response (relative value)

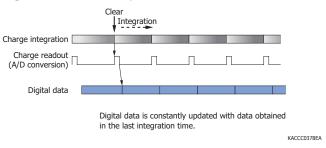


 $^{^{\}star}$ A/D count when constant light level enters optical fiber (Fiber core diameter: 600 μm , assuming no attenuation in optical fiber)

Free-run operation (normal operation mode)

When light enters an image sensor, an electrical charge is generated in each pixel of the image sensor according to the incident light level. This charge accumulates in each pixel during the integration time and is cleared to zero when read out. This means that the charge must be read out before starting integration of newly generated charges. In mini-spectrometers, this cycle of "charge integration → charge readout (A/D conversion) → digital data hold" repeats in a cycle. Digital data is constantly updated with data obtained in the latest integration time. When a data request is received from the PC, the mini-spectrometer sends the latest data at that point to the PC. Figure 13 shows the free-run operation.

[Figure 13] Free-run operation



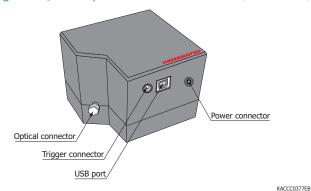
Operation mode when trigger is input [TM/TG series (USB 1.1 compatible)]*1

The TM/TG series mini-spectrometers (USB 1.1 compatible) that support external trigger operation can acquire data based on external trigger signal input.

The external trigger function works with DLL, but does not function on the supplied evaluation software. Therefore, when using an external trigger function, the user software must be configured to support that function.

Use the A10670 coaxial cable for external trigger (sold separately) to connect the mini-spectrometer to a device that outputs digital signals at 0 V to 5 V levels.

[Figure 14] Mini-spectrometer connectors (C10082CA)



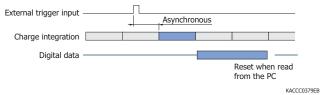
Operation modes using external trigger input are described below.

(1) Data hold by external trigger input

This operation mode differs from free-run operation in that data to be held is controlled by trigger input. The minispectrometer internally holds digital data accumulated during the integration time that begins just after the trigger input edge (rising or falling edge can be specified). This data being held is then reset when it is read out from the PC. If the next trigger is input while the data is still being held, then that data is updated to new digital data.

For example, when a mini-spectrometer is used to detect light emitted from a DC mode light source with a shutter installed, then data accumulated in a predetermined integration time can be held by supplying the minispectrometer with a trigger input for shutter open operation. Measurements can be made under high repeatability conditions by setting a shutter open period that is sufficiently longer than the integration time.

[Figure 15] Data hold responding to external trigger input



(2) Data labeling during external trigger input

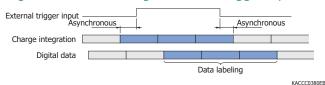
This operation mode attaches a label to digital data during the gate period for external trigger input. A label is attached to digital data during trigger input (high level or low level can be specified). When the digital data is read out from the PC, the label information can be obtained at the same time.

[Table 3] Operation mode compatibility table

Operation mode	C9913GC, C9914GB C11007MA, C11008MA	C9404CA, C9404CAH, C10082CA C10082CAH, C10082MD, C10083CA C10083CAH, C10083MD, C11713CA Refer to *1 (P.32).	C11118GA, C11697MB C11482GA, C13555MA C13053MA, C13054MA C14486GA, C14214MA Refer to *2 (P.33).
Free-run operation	\circ	\circ	\circ
External trigger operation	×	0	0
Software trigger operation	×	×	0

When acquiring data under different measurement conditions, this mode is suitable for identifying which measurement condition applies to the measurement data. For example, suppose measurements are made under condition A and condition B. Condition A uses no trigger input to make measurements, so there is no labeling. In contrast, condition B uses a trigger input, so a label is attached to the acquired data. Labeling the acquired data in this way during trigger input makes it possible to distinguish between acquired data measurement conditions.

[Figure 16] Data labeling at external trigger input

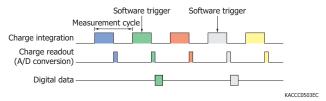


Operation mode when trigger is input [TM/TG/TF series (USB 2.0 compatible)]*2

The TM/TG/TF series mini-spectrometers (USB 2.0 compatible) can acquire data based on trigger signal input from a PC. It is also possible to acquire and output data using an external trigger signal received through the trigger connector. The operation mode can be selected from the evaluation software supplied with the mini-spectrometer.

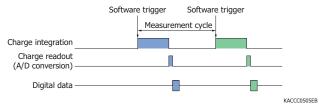
(1) Asynchronous data measurement at software trigger input The first piece of digital data that is converted after a software trigger is applied from the PC is acquired.

[Figure 17] Asynchronous data measurement at software trigger input



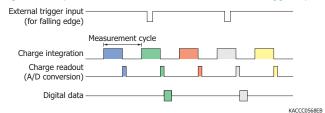
(2) Synchronous data measurement at software trigger input Data integration starts when a software trigger is applied from the PC.

[Figure 18] Synchronous data measurement at software trigger input



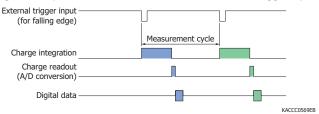
(3) Asynchronous data measurement at external trigger input The first piece of digital data that is converted after an external trigger edge (rising or falling edge can be specified) is applied to the trigger connector is acquired.

[Figure 19] Asynchronous data measurement at external trigger input



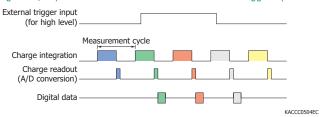
(4) Synchronous data measurement at external trigger input Data integration starts when an external trigger edge (rising or falling edge can be specified) is applied to the trigger connector, and then the digital data is acquired.

[Figure 20] Synchronous data measurement at external trigger input



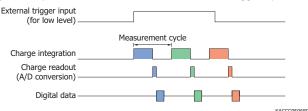
(5) Asynchronous data measurement at external trigger input level Digital data is acquired when an external trigger (high level or low level can be specified) is applied to the trigger connector.

[Figure 21] Asynchronous data measurement at external trigger input level



(6) Synchronous data measurement at external trigger input level Data integration starts when a trigger (high level or low level can be specified) is applied to the trigger connector, and then the digital data is acquired.

[Figure 22] Synchronous data measurement at external trigger input level

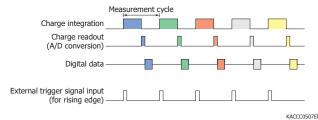


In any of the above modes (1) to (6), if the trigger input cycle is shorter than the measurement cycle of the minispectrometer, the input trigger is ignored.

(7) External trigger signal output

The start timing (pulse width: 10 µs) of integration can be output from the trigger connector (trigger output edge: rising or falling edge can be specified).

[Figure 23] External trigger signal output





Most Hamamatsu mini-spectrometers come with an evaluation software package.

Evaluation software functions

By installing the evaluation software into a PC, you can perform the following basic operations.

- · Acquire and save measured data
- · Set measurement conditions
- \cdot Module information acquisition (wavelength conversion factor*1, mini-spectrometer type, etc.)
- · Display graphs
- · Arithmetic functions

Pixel number to wavelength conversion/calculation in comparison with reference data (transmittance, reflectance)/dark subtraction/Gaussian approximation (peak position and count, FWHM)

*1: A factor for converting the pixel numbers of the image sensor to wavelengths. However, a factor for converting the count values after A/D conversion into incident light levels is not available.

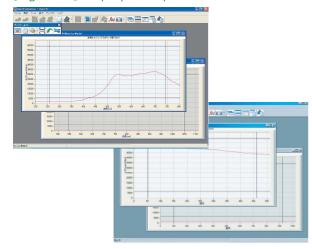
> Evaluation software types

The following five types of evaluation software are available. Each type can only be used for specific minispectrometers.

- · For the TM/TG series (USB 1.1 interface)
- · For the TM/TG/TF series (USB 2.0 interface)
- · For the RC series

- · For evaluation circuit C14465 series
- · For evaluation circuit C13016
- · For evaluation circuit C14989

[Figure 24] Display examples of evaluation software



The evaluation software has measurement modes including Monitor, Measure, Dark, and Reference. Table 5 shows the features of each mode. Data measured in Measure mode, Dark mode*2, and Reference mode*2 can be saved in csv format (loadable into Microsoft® Excel®).

Table 6 shows the arithmetic functions of the evaluation software, and Table 7 shows limitations on setting parameters during measurement.

*2: The C11118GA, C11697MB, C11482GA, C13053MA, C13054MA, C13555MA, C14486GA, C14214MA, C14465 series, and C13016 do not have Dark or Reference mode. The Measure mode serves as the Dark and Reference modes.

[Table 4] Evaluation software compatibility table

		NA:-:	TM/TC/TC::				l	
	Parameter		Mini-spectrometer TM/TG/TF series USB 1.1 USB 2.0		Evaluation circuit	Evaluation circuit	Evaluation circuit	
			USB 2.0	RC series	C14465 series	C13016	C14989 + C15036	
Applicable mini-spectrometers		C10082CA C10082CAH C10082MD C10083CA C10083CAH C10083MD C9404CA C9404CAH C11713CA C9913GC C9914GB	C11482GA C11118GA C11697MB C13555MA C13053MA C13054MA C14486GA C14214MA	C11007MA C11008MA	C11708MA C12666MA	C12880MA	C14384MA-01	
Compatible	Windows 8.1 Professional (32-bit, 64-bit)	0	0	0	0	0	0	
OS	Windows 10 Professional (32-bit, 64-bit)	0	0	0	0	0	0	
Disclosure of	DLL function specifications	0	0	0	0	0	0	
Connecting and driving multiple mini- spectrometers from a single PC (evaluation software)		0	0	-	-	-	-	
Multiple data transfer function		-	0	-	-	-	-	
Compatible	Visual C++®/CLI	0	0	0	0	0	0	
development	Visual Basic®	0	0	0	0	0	0	
environment	LabVIEW	-	-	-	-	-	-	
Source code disclosure		-	-	-	-	-	-	

[Table 5] Measurement modes of evaluation software

Mode	Overview	Features	
		Graphically displays "pixel no. vs. A/D output value" in real time	
		Graphically displays "wavelength vs. A/D output value" in real time	
		Graphically displays time-series data at a selected wavelength*3	
Monitor mode	Measurement mode not intended to save	Cannot save measurement data	
Women mode	acquired data	Performs dark subtraction	
		Displays reference data	
		Cannot set the number of measurement scans. No limit on scan count.	
		Graphically displays "pixel no. vs. A/D output value" in real time	
		Graphically displays "wavelength vs. A/D output value" in real time	
		Graphically displays time-series data at a selected wavelength*3	
Measure mode	Measurement mode intended to save acquired data	Saves measurement data	
		Performs dark subtraction	
		Displays reference data	
		Sets the number of measurement scans	
	NASSAURS DE LOS DELOS DE LOS DELOS DE LOS DELOS DE LOS DELOS DE LOS DE L	Graphically displays "pixel no. vs. A/D output value" in real time	
Dark mode*4		Graphically displays "wavelength vs. A/D output value" in real time	
		Saves measurement data	
		Graphically displays "pixel no. vs. A/D output value" in real time	
Reference mode*4	Measurement mode for acquiring reference data	Graphically displays "wavelength vs. A/D output value" in real time	
		Saves measurement data	
		Software trigger, asynchronous measurement	
		Software trigger, synchronous measurement	
Trigger mode*3	Measurement mode for acquiring data by	External trigger, asynchronous edge	
rrigger mode	trigger signal	External trigger, asynchronous level	
		External trigger, synchronous edge	
		External trigger, synchronous level	
Continuous		Graphically displays "pixel no. vs. A/D output value" at completion of data transfer	
measurement mode* ³	Continuous data acquisition by batch data transfer	Graphically displays "wavelength vs. A/D output value" at completion of data transfer	
		Saves measurement data	

[Table 6] Arithmetic functions of evaluation software

Function	Features
Dark subtraction	Displays measurement data after dark data subtraction
Reference data measurement/display	Measures reference data and displays it graphically
Gaussian fitting	Fits a specified range of data using a Gaussian function

^{*3:} Only supported by the C11118GA, C11697MB, C11482GA, C13053MA, C13054MA, C13555MA, C14486GA, and C14214MA *4: The C11118GA, C11697MB, C11482GA, C13053MA, C13555MA, C14486GA, C14214MA, C14465 series, and C13016 do not have Dark or Reference mode. The Measure mode serves as the Dark and Reference modes.

[Table 7] Limitations on setting parameters

Parameter	Limitation				
	1 μs to 100 ms	C14486GA			
	11 μs to 100 ms* ⁵	C13555MA, C13053MA, C13054MA, C14214MA, C13016, C14989			
	30 μs to 100 ms* ⁵	C11697MB			
Integration	6 μs to 40 ms* ⁵	C11118GA			
time	5 ms to 1 s	C9914GB			
	5 ms to 10 s	C10082MD, C10083MD, C9913GC, C11007MA, C11008MA, C14465, C14465-01			
	6 μs to 10 s* ⁵	C11482GA			
	10 ms to 10 s	C10082CA, C10082CAH, C10083CA, C10083CAH, C9404CA, C9404CAH, C11713CA			
Gain	High/Low	C10082MD, C10083MD, C11482GA, C9913GC, C9914GB, C11007MA, C11008MA, C11118GA			
Scan count	The number of times continuous measurement can be performed in continuous measurement mode depends on the memory size and operation status of the PC (not limited during Monitor mode).				

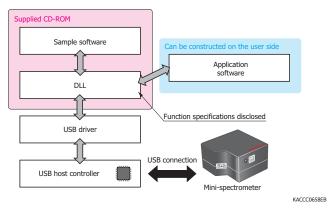
^{*5:} Specified in 1 µs steps

Interface

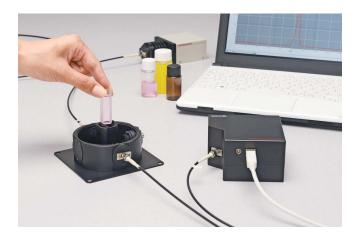
Mini-spectrometers come with DLLs. By using this DLL, users can create Windows applications for controlling minispectrometers in a software development environment such as Visual C++/CLI and Visual Basic*6. Because Windows application software cannot directly access a USB host controller, the necessary functions should be called from the DLL to allow the software to access the USB host controller via the USB driver and to control the minispectrometer (see Figure 25). The DLL provides functions for opening/closing USB ports, setting measurement conditions, getting data and module information, and so on.

Note: Microsoft, Windows, Excel, Visual C++/CLI, Visual Basic, and Visual Studio are either registered trademarks or trademarks of Microsoft Corporation in the United States and/or other countries.

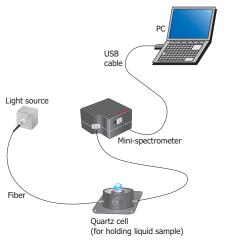
[Figure 25] Software configuration example



^{*6:} Operation has been verified using Visual Studio[®] 2010, 2013, 2015 Visual C++/CLI and Visual Studio 2010, 2013, 2015 Visual Basic on .NET Framework 3.5, 4.0, 4.5 (Windows 8.1, 10).



[Figure 26] Connection example (measurement of liquid absorbance)

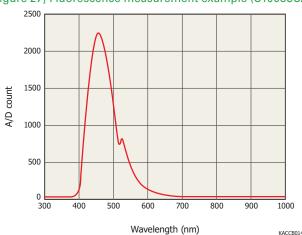


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>> Fluorescence measurement

This is an example of measuring fluorescence from a 1000 ppm quinine solution (buffer solution: dilute sulfuric acid).

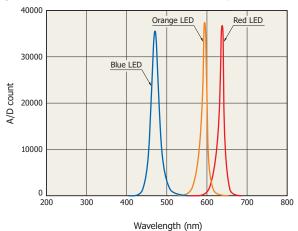
[Figure 27] Fluorescence measurement example (C10083CA)



> LED emission measurement

(1) Visible LED

[Figure 28] Visible LED measurement example (C10082MD)

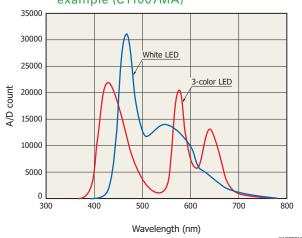


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(2) White LED and 3-color LED

Figure 29 is an example of measuring emissions from a white LED and 3-color LED. White LED light contains wavelength components of various colors as well as blue, and appears white because those colors are mixed together.

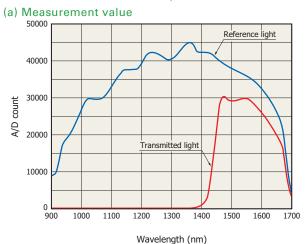
[Figure 29] White LED and 3-color LED measurement example (C11007MA)



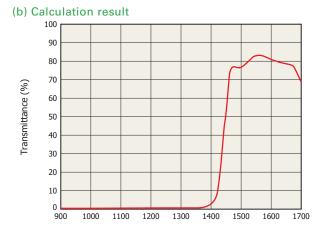
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>> Transmittance measurement

[Figure 30] Transmittance (1 mm thick optical window) measurement example (C11482GA)



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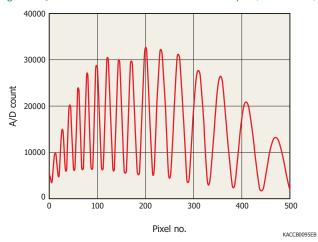
Wavelength (nm)

KACCB0277EA

> Film thickness measurement

Here we show an example that measures the film thickness of 10 μm thick food wrap (polyvinylidene chloride). In film thickness measurement utilizing white light interferometry, a rippling interference spectrum is obtained due to reflections between the front and back surfaces of the film. The film thickness can then be determined by calculation from the spectral peak count, wavelength range, refractive index of film, and the angle of incident light.

[Figure 31] Film thickness measurement example (C11482GA)



Related products

Input optical fibers A15362-01, A15363-01

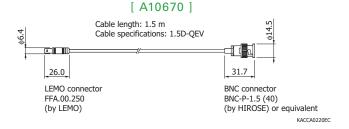
As accessories for the mini-spectrometers, UV-visible optical fiber (UV resistant) and visible-NIR optical fiber with a core diameter of 600 µm are available (sold separately). Note that the fiber is incorporated in the C11009MA and C11010MA of the mini-spectrometer RC series.

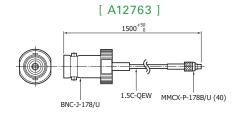
Type no.	Product name	Applicable mini-spectrometers	Core diameter (µm)	Specifications
A15362-01	(LIV light resistant)	C10082CA, C10082CAH, C10083CA, C10083CAH C10082MD, C10083MD, C9404CA, C9404CAH C11007MA, C11697MB, C13555MA	600	NA=0.22, 1.5 m in length,
A15363-01	fibor	C11482GA, C9913GC, C9914GB, C11008MA, C11118GA, C11713CA, C13053MA, C13054MA, C14214MA, C14486GA	000	with SMA905D connector on each end

External trigger coaxial cables A10670, A12763

Type no.	Applicable mini-spectrometers
	C9404CA, C9404CAH, C10082CA, C10082CAH, C10082MD, C10083CA, C10083CAH, C10083MD, C11713CA, C11118GA, C11697MB, C11482GA
A12763	C13555MA, C13053MA, C13054MA, C14486GA, C14214MA

Dimensional outlines (unit: mm)





KACCA0358EA

Spectroscopic module C13560

These are compact, lightweight Raman spectroscopy analysis modules. A compact spectrometer, excitation light source, wavelength filter, and other optical elements are integrated into a single unit. The modules can be used for onsite screening tests and other applications that use Raman spectroscopy. In addition, using the surface-enhanced Raman spectroscopy (SERS) substrate makes high-sensitivity Raman spectroscopic analysis possible. The C13560 is a palm-sized lightweight type.



C13560

2 W xenon flash lamp module L13651 series

The L13651 series is a 2 W xenon flash lamp module integrated with a power supply and a trigger socket. This product is not only an ideal light source for compact analysis equipment used in environmental analysis, sampling tests, and the like but also can be incorporated in portable analysis equipment used in high accuracy environment monitoring, POCT, and the like with operation on a 5 V mobile battery, whose development is expected in the future.

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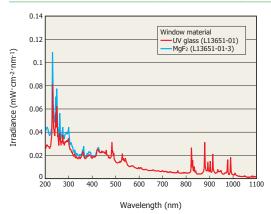
Features

■ Compact: 42 × 42 × 37 mm ■ Operates on 5 V mobile battery

■ Long life: 1 × 10⁹ flash ■ Repetition rate: 1250 Hz max.

■ Broad spectrum: UV region to middle IR region

Spectral irradiance (typical example)



Measurement conditions
Main discharge voltage: 600 V
Main discharge capacitance: 0.141 µF
Repetition rate: 79 Hz
Detectors: Photomultiplier tube (Cs-Te photocathode) (200 nm to 320 nm)
Photomultiplier tube (multialkali photocathode) (280 nm to 720 nm)
Si photocidode (680 nm to 1100 nm)
Measurement distance: 50 cm

40



Date.
No.

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Solid State Division, HAMAMATSU PHOTONICS K.K.

1126-1, Ichino-cho, Higashi-ku, Hamamatsu City, 435-8558, Japan Telephone: (81)53-434-3311, Fax: (81)53-434-5184

www.hamamatsu.com

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Sales Offices

Japan.

HAMAMATSU PHOTONICS K.K.

325-6, Sunayama-cho, Naka-ku, Hamamatsu City, Shizuoka Pref. 430-8587, Japan Telephone: (81)53-452-2141, Fax: (81)53-456-7889 E-mail: intl-div@hq.hpk.co.jp

China:

HAMAMATSU PHOTONICS (CHINA) Co., Ltd. Main Office

Chaoyang District, 100020 Beijing, P.R. China Telephone: (86)10-6586-6006, Fax: (86)10-6586-2866 E-mail: hpc@hamamatsu.com.cn

Shanghai Branch

4905 Wheelock Square, 1717 Nanjing Road West, Jingan District, 200040 Shanghai, P.R. China Telephone: (86)21-6089-7018, Fax: (86)21-6089-7017

Shenzhen Branch

14F CHINA MERCHANTS TOWER 1#, NO. 1166 Wanghai Road, Shekou, Nanshan district, Shenzhen, P.R. China Telephone: (86)755-2165-9058, Fax: (86)755-2165-9056 E-mail: hpcsz@hamamatsu.com.cn

Taiwan:

HAMAMATSU PHOTONICS TAIWAN Co., Ltd. Main Office

8F-3, No.158, Section 2, Gongdao 5th Road, East District, Hsinchu, 300, Taiwan R.O.C. Telephone: (886)3-659-0080, Fax: (886)3-659-0081 F-mail: info@hamantsu.com.tw

U.S.A.:

HAMAMATSU CORPORATION

Main Office

360 Foothill Road, Bridgewater, NJ 08807, U.S.A. Telephone: (1)908-231-0960, Fax: (1)908-231-1218 E-mail: usa@hamamatsu.com

California Office

2875 Moorpark Ave., San Jose, CA 95128, U.S.A. Telephone: (1)408-261-2022, Fax: (1)408-261-2522 E-mail: usa@hamamatsu.com

Chicago Office

4711 W. Golf Road, Suite 805, Skokie, IL 60076, U.S.A. Telephone: (1)847-825-6046, Fax: (1)847-825-2189 E-mail: usa@hamamatsu.com

Boston Office

20 Park Plaza, Suite 312, Boston, MA 02116, U.S.A. Telephone: (1)617-536-9900, Fax: (1)617-536-9901 E-mail: usa@hamamatsu.com

Germany, The Netherlands, Poland, Denmark, Israel: HAMAMATSU PHOTONICS DEUTSCHLAND GmbH Main Office

Arzbergerstr. 10, D-82211 Herrsching am Ammersee, Germany

Telephone: (49)8152-375-0, Fax: (49)8152-265-8 E-mail: info@hamamatsu.de

Netherlands Office

Transistorstraat 7, NL-1322 CJ Almere, The Netherlands

Telephone: (31)36-5405384, Fax: (31)36-5244948 E-mail: info@hamamatsu.nl

Poland Office

10 Ciolka Street, RN 126-127 01-402 Warsaw, Poland Telephone: (48)22-646-0016, Fax: (48)22-646-0018 E-mail: poland@hamamatsu.de

Danish Office

Lautruphøj 1-3, DK-2750 Ballerup, Denmark Telephone: (45)70 20 93 69, Fax: (45)44 20 99 10 Email: info@hamamatsu.dk

Israel Office (Hamamatsu Photonics Israel Ltd.) Hahoshlim 6, Building C, 4672201 Herzliya, Israel E-mail: Info@hamamatsu.co.il

France, Switzerland, Belgium, Spain:

HAMAMATSU PHOTONICS FRANCE S.A.R.L.

Main Office

19, Rue du Saule Trapu, Parc du Moulin de Massy, 91882 Massy Cedex, France Telephone: (33)1 69 53 71 00, Fax: (33)1 69 53 71 10 E-mail: infos@hamamatsu.fr

Swiss Office

Dornacherplatz 7, 4500 Solothurn, Switzerland Telephone: (41)32-625-60-60, Fax: (41)32-625-60-61 E-mail: swiss@hamamatsu.ch

Belgian Office

Axisparc Technology, rue Andre Dumont 7 1435 Mont-Saint-Guibert, Belgium Telephone: (32)10 45 63 34, Fax: (32)10 45 63 67 E-mail: info@hamamatsu.be

Spanish Office

C. Argenters, 4 edif 2 Parque Tecnológico del Vallés 08290 Cerdanyola (Barcelona), Spain Telephone: (34)93 582 44 30, Fax: (34)93 582 44 31 E-mail: infospain@hamamatsu.es

North Europe and CIS:

HAMAMATSU PHOTONICS NORDEN AB

Main Office

Torshamnsgatan 35 16440 Kista, Sweden Telephone: (46)8-509 031 00, Fax: (46)8-509 031 01 E-mail: info@hamamatsu.se

Russian Office

11, Christoprudny Boulevard, Building 1, Office 114, 101000, Moscow, Russia Telephone: (7)495 258 85 18, Fax: (7)495 258 85 19

E-mail: info@hamamatsu.ru

HAMAMATSU PHOTONICS ITALIA S.r.I.

Main Office

Strada della Moia, 1 int. 6, 20020 Arese (Milano), Italy Telephone: (39)02-93 58 17 33, Fax: (39)02-93 58 17 41 E-mail: info@hamamatsu.it

Rome Office

Viale Cesare Pavese, 435, 00144 Roma, Italy Telephone: (39)06-50 51 34 54 E-mail: inforoma@hamamatsu.it

United Kingdom:

HAMAMATSU PHOTONICS UK Limited

Main Office

2 Howard Court, 10 Tewin Road, Welwyn Garden City, Hertfordshire AL7 1BW, UK Telephone: (44)1707-294888, Fax: (44)1707-325777 E-mail: info@hamamatsu.co.uk

South Africa Contact:

9 Beukes Avenue, Highway Gardens, Edenvale 1609 South Africa

Telephone/Fax: (27)11-609-0367

